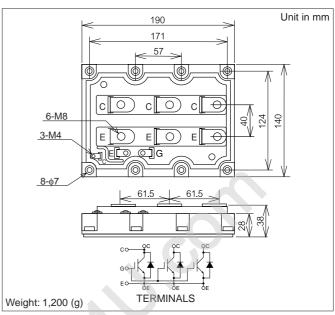
MBN1200D33A

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High thermal fatigue durability.
 (delta Tc=70°C,N>20,000cycles)
- * low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- *High speed,low loss IGBT module.
- *Low driving power due to low input capacitance MOS gate.
- *High reliability, high durability module.
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

ltem		Symbol	Unit	MBN1200D33A			
Collector Emitter Voltage		V _{CES}	V	3,300			
Gate Emitter Voltage		V_{GES}	V	±20			
Collector Current	DC	Ic	Α	1,200			
	1ms	I _{Cp}	A	2,400			
Forward Current	DC	IF	^	1,200			
	1ms	I _{FM}	Α	2,400			
Collector Power Dissipation		Pc	W	12,000			
Junction Temperature	Tj	°C	-40 ~ +125				
Storage Temperature	T _{stg}	°C	-40 ~ +125				
Isolation Voltage		V _{ISO}	V_{RMS}	5,400(AC 1 minute)			
Screw Torque Ter	minals(M4/M8)	-	N.m	2/10 (1)			
Mo	unting(M6)	-		6 (2)			

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

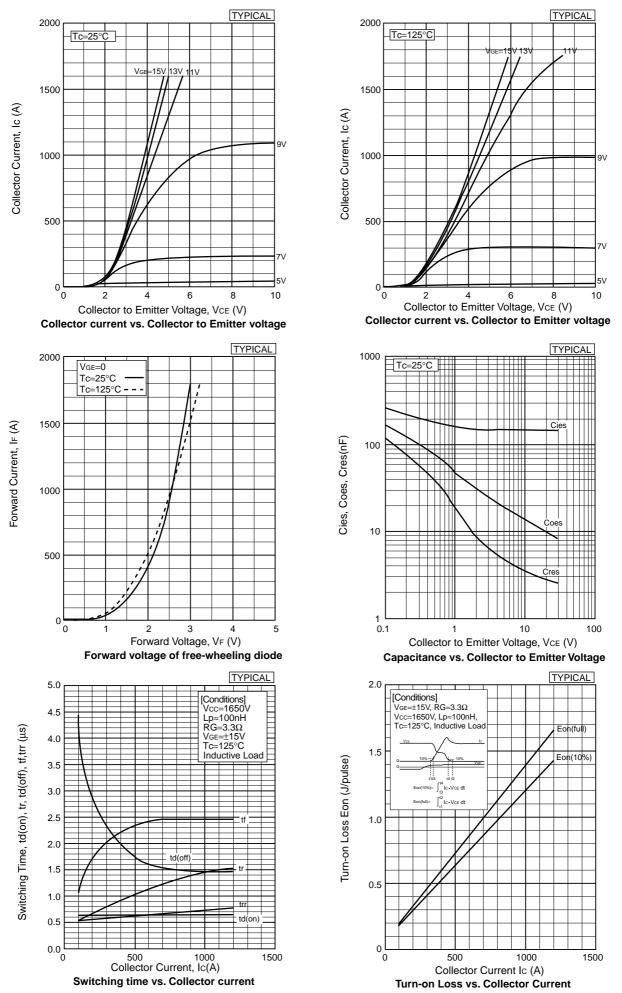
(2)Recommended Value 5.5±0.5N.m

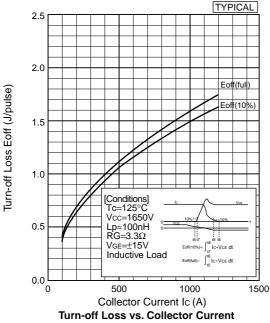
CHARACTERISTICS (Tc=25°C)

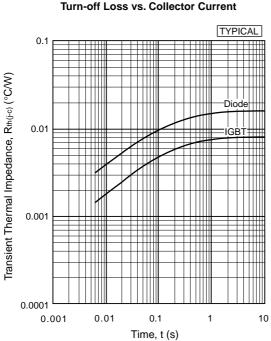
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	12.0	V _{CE} =3,300V,V _{GE} =0V
Gate Emitter Leakage Current		I _{GES}	nA	-	-	±500	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	4.1	5.0	I _C =1,200A,V _{GE} =15V
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	4.0	5.5	7.0	V _{CE} =10V, I _C =1,200mA
Input Capacitance		Cies	nF	-	150	-	V _{CE} =10V,V _{GE} =0V,f=100KHz
	Rise Time	tr		-	1.6	2.6	Vcc=1,650V,Ic=1,200A
Switching Times	Turn On Time	t _{on}	μS	-	2.3	3.2	L=100nH
· ·	Fall Time	t _f		-	2.4	3.2	$R_G=3.3\Omega$ (3)
	Turn Off Time	t _{off}		-	3.9	5.6	V _{GE} =±15V Tc=125°C
Peak Forward Voltage Drop		V_{FM}	V	-	2.8	3.7	-Ic=1,200A,V _{GE} =0V
Reverse Recovery Time		t _{rr}	μS	-	0.8	1.4	Vcc=1,650V,-lc=1,200A,L=100nH,
							Tc=125°C (4)
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.008	Junction to case
	FWD	Rth(j-c)		-	-	0.016	5

Notes:(3) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.

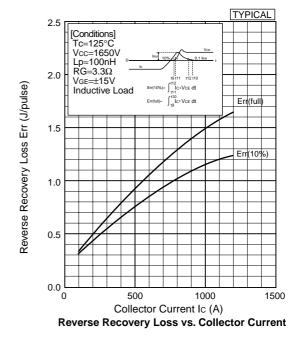
(4) Counter arm IGBT V_{GE}=-15V







Transient thermal impedance



HITACHI POWER SEMICONDUCTORS

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